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10655854

Title of Invention:

MULTI-LAYER INTEGRATED

SEMICONDUCTOR STRUCTURE

First Named Inventor:

Rafael Reif

Domestic/Foreign Application:

Domestic Application

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Information Disclosure

Statement

Filing Type:

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MIT-136AUS

Total Fees Authorized:

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TRANSMITTAL

Electronic Version v1.1 Stylesheet Version v1.1.0

> Title of Invention

MULTI-LAYER INTEGRATED SEMICONDUCTOR STRUCTURE

Application Number:

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First Named Applicant: Rafael Reif

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| Submitted by: | Elec. Sign. | Sign. Capacity | |
|---|-------------|----------------|--|
| Christopher S Daly Registered Number: 37,303 | /csd/ | Attorney | |

Documents being submitted

Files

us-ids

MIT-136AUS-usidst.xml

us-ids.dtd

us-ids.xsl

Comments



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18 Stylesheet Version v18.0

> Title of Invention

MULTI-LAYER INTEGRATED SEMICONDUCTOR **STRUCTURE**

Application Number:

10/655854

Confirmation Number:

7254

First Named Applicant:

Rafael Reif

Attorney Docket Number: MIT-136AUS

Art Unit:

2811

Search string:

(4313126 or 4402761 or 4456888 or 4599704

or 4986861 or 5156997 or 5206186 or 5445994

or 5821138 or 5923087 or 6441478).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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Signature

| Examiner Name | Date |
|---------------|------|
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